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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR 84N06CLD, NP84N06DLD, NP84N06ELD

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance $R_{DS(on)1}=6.5~m\Omega~MAX.~(V_{GS}=10~V,~I_{D}=42~A)$ $R_{DS(on)2}=9.5~m\Omega~MAX.~(V_{GS}=5~V,~I_{D}=35~A)$
- · Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP84N06CLD	TO-220AB
NP84N06DLD	TO-262
NP84N06ELD	TO-263

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0)	Voss	60	V
Gate to Source Voltage ($V_{DS} = 0$)	V_{GSS}	±20	V
Drain Current (DC) Note1	$I_{D(DC)}$	±84	Α
Drain Current (Pulse) Note2	$I_{D(pulse)}$	±280	Α
Total Power Dissipation (T _A = 25°C)	P_{T1}	1.8	W
Total Power Dissipation (T _C = 25°C)	P_{T2}	185	W
Channel Temperature	Tch	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Single Avalanche Current Note3	I _{AS}	Figure4	Α
Single Avalanche Energy Note3	Eas	Figure4	mJ
Repetitive Avalanche Current Note4	I _{AR}	70	Α
Repetitive Avalanche Energy Note4	E _{AR}	490	mJ

Notes 1. Package Limit = \pm 75 A

- **2.** PW \leq 10 μ s, Duty cycle \leq 1 %
- 3. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V
- **4.** Tch \leq 175°C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0 V, Duty cycle \leq 3%

THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	0.81	°C/W	
Channel to Ambient	R _{th} (ch-A)	83.3	°C/W	

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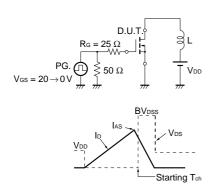


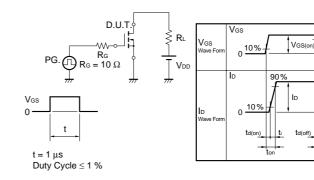
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Ib = 42 A		5.5	6.5	mΩ
	RDS(on)2	Vgs = 5 V, ID = 35 A		6.4	9.5	mΩ
	RDS(on)3	Vgs = 4 V, ID = 35 A		7.0	10.5	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0	1.5	2.0	>
Forward Transfer Admittance	yfs	Vps = 10 V, Ip = 35 A	20	94		S
Drain Leakage Current	Ipss	Vps = 60 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	Vps = 10 V		7200	10900	pF
Output Capacitance	Coss	Vgs = 0 V		2000	3000	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		700	1300	pF
Turn-on Delay Time	t _{d(on)}	ID = 35 A		50	110	ns
Rise Time	tr	VGS(on) = 10 V		650	1700	ns
Turn-off Delay Time	T _{d(off)}	V _{DD} = 30 V		450	900	ns
Fall Time	t f	$R_G = 10 \Omega$		800	2000	ns
Total Gate Charge	Q _G	ID = 70 A		150	230	nC
Gate to Source Charge	Qgs	V _{DD} = 48 V		19		nC
Gate to Drain Charge	Q _{GD}	Vgs = 10 V		40		nC
Body Diode Forward Voltage	VF(S-D)	IF = 70 A, VGS = 0 V		0.97		V
Reverse Recovery Time	trr	IF = 70A, VGS = 0 V		80		ns
Reverse Recovery Charge	Qrr	di/dt = 100A/μs		256		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME





90%

10%

TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} D.U.T. \\ \hline \\ Ic = 2 \text{ mA} \\ \hline \\ \hline \\ VDC \\ \end{array}$$

TYPICAL CHRACTERISTICS (TA = 25°C)

Figure 1. DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

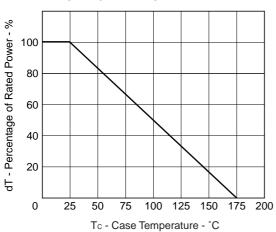


Figure.3 FORWARD BIAS SAFE OPERATING AREA

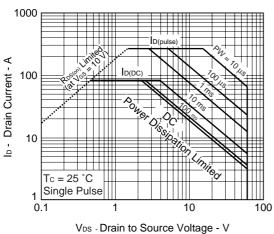


Figure 5. FORWARD TRANSFER CHARACTERISTICS

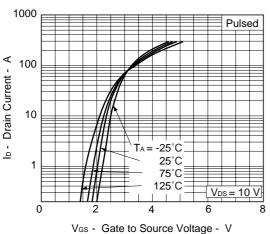


Figure2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

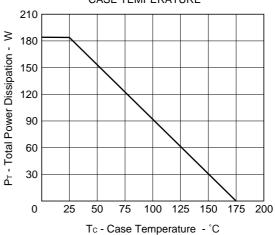
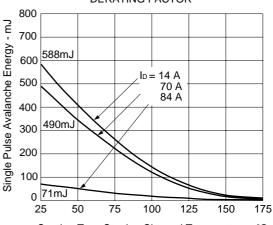
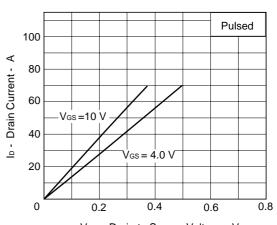


Figure4. SINGLE AVALANCHE ENERGY DERATING FACTOR



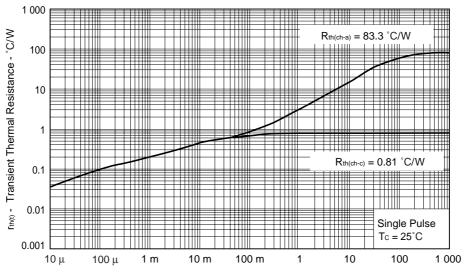
Starting T_{ch} - Starting Channel Temperature - $^{\circ}C$

Figure6. DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



V_{DS} - Drain to Source Voltage - V

Figure 7. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s

Figure 8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

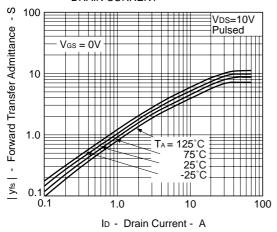


Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

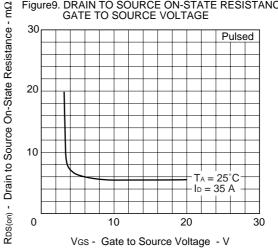


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

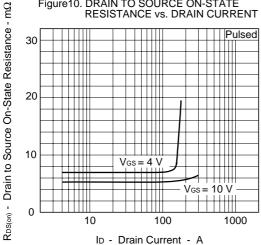
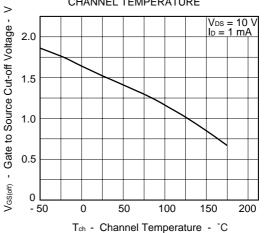
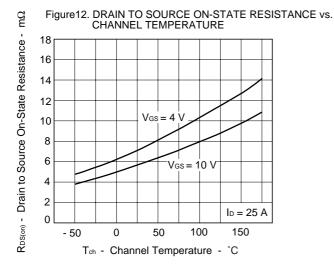
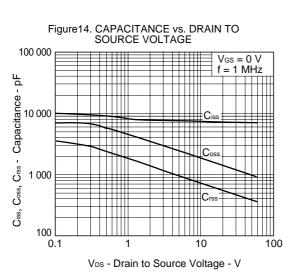
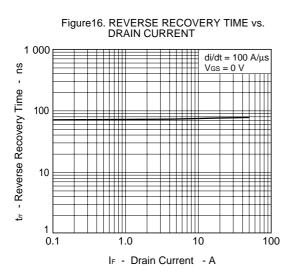


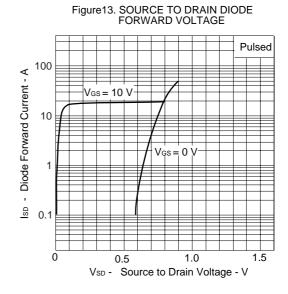
Figure 11. GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

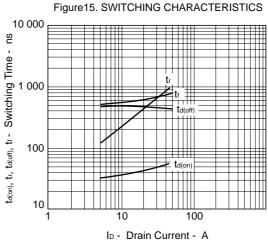


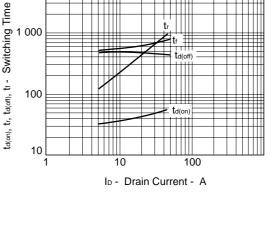


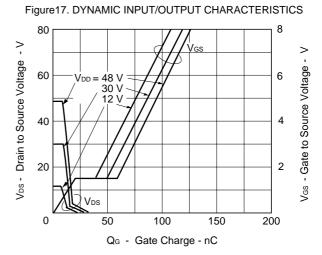






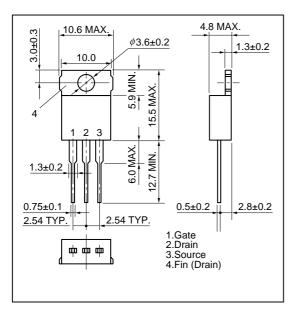




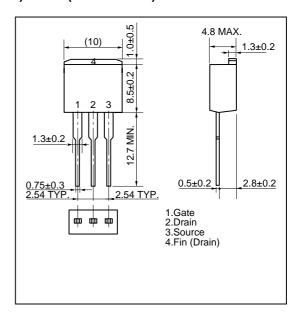


PACKAGE DRAWINGS (Unit: mm)

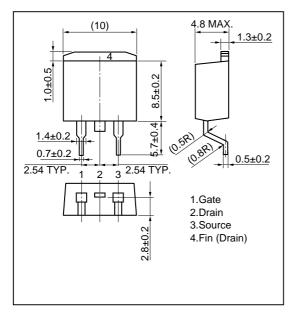
1)TO-220AB (MP-25)



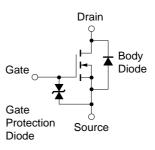
2)TO-262 (MP-25 Fin Cut)



3)TO-263 (JEDEC TYPE:MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



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